

# SN74F543 OCTAL REGISTERED TRANSCEIVER WITH 3-STATE OUTPUTS

SDFS025B – D2942, MARCH 1987 – REVISED OCTOBER 1993

- 3-State True Outputs
- Back-to-Back Registers for Storage
- Package Options Include Plastic Small-Outline and Shrink Small-Outline Packages and Standard Plastic 300-mil DIPs

## description

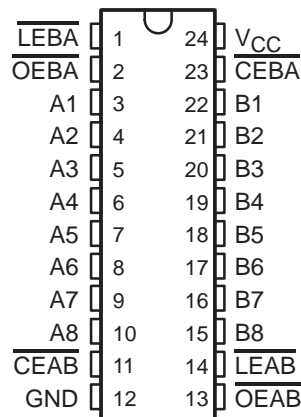
The SN74F543 octal transceiver contains two sets of D-type latches for temporary storage of data flowing in either direction. Separate latch-enable ( $\overline{LEAB}$  or  $\overline{LEBA}$ ) and output enable ( $\overline{OEAB}$  or  $\overline{OEBA}$ ) inputs are provided for each register to permit independent control in either direction of data flow. The A outputs are characterized to sink 24 mA while the B outputs are characterized to sink 64 mA.

The A-to-B enable ( $\overline{CEAB}$ ) input must be low in order to enter data from A or to output data from B. Having  $\overline{CEAB}$  low and  $\overline{LEAB}$  low makes the A-to-B latches transparent; a subsequent low-to-high transition of  $\overline{LEAB}$  puts the A latches in the storage mode. With  $\overline{CEAB}$  and  $\overline{OEAB}$  both low, the 3-state B outputs are active and reflect the data present at the output of the A latches. Data flow from B to A is similar, but requires using the  $\overline{CEBA}$ ,  $\overline{LEBA}$ , and  $\overline{OEBA}$  inputs.

The SN74F543 is available in TI's shrink small-outline package (DB), which provides the same I/O pin count and functionality of standard small-outline packages in less than half the printed-circuit-board area.

The SN74F543 is characterized for operation from 0°C to 70°C.

DB, DW, OR NT PACKAGE  
(TOP VIEW)



FUNCTION TABLE†

INPUTS				OUTPUT
$\overline{CEAB}$	$\overline{LEAB}$	$\overline{OEAB}$	A	B
H	X	X	X	Z
X	X	H	X	Z
L	H	L	X	$B_0^\ddagger$
L	L	L	L	L
L	L	L	H	H

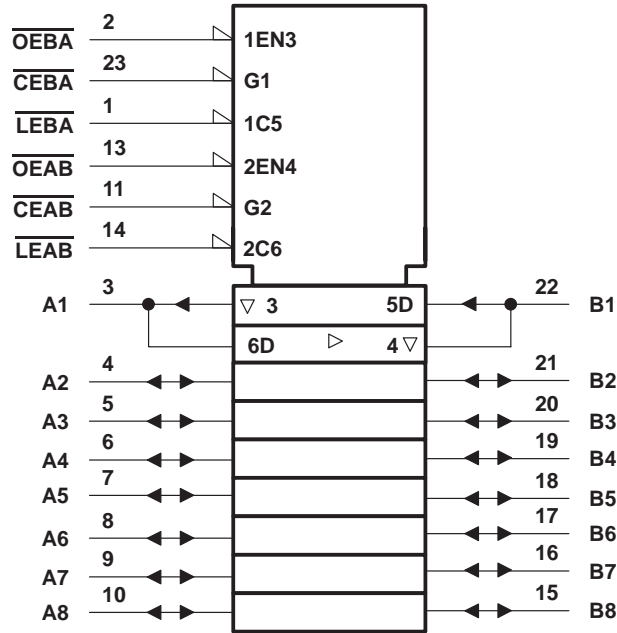
† A-to-B data flow is shown; B-to-A flow control is the same except that it uses  $\overline{CEBA}$ ,  $\overline{LEBA}$ , and  $\overline{OEBA}$ .

‡ Output level before the indicated steady-state input conditions were established.

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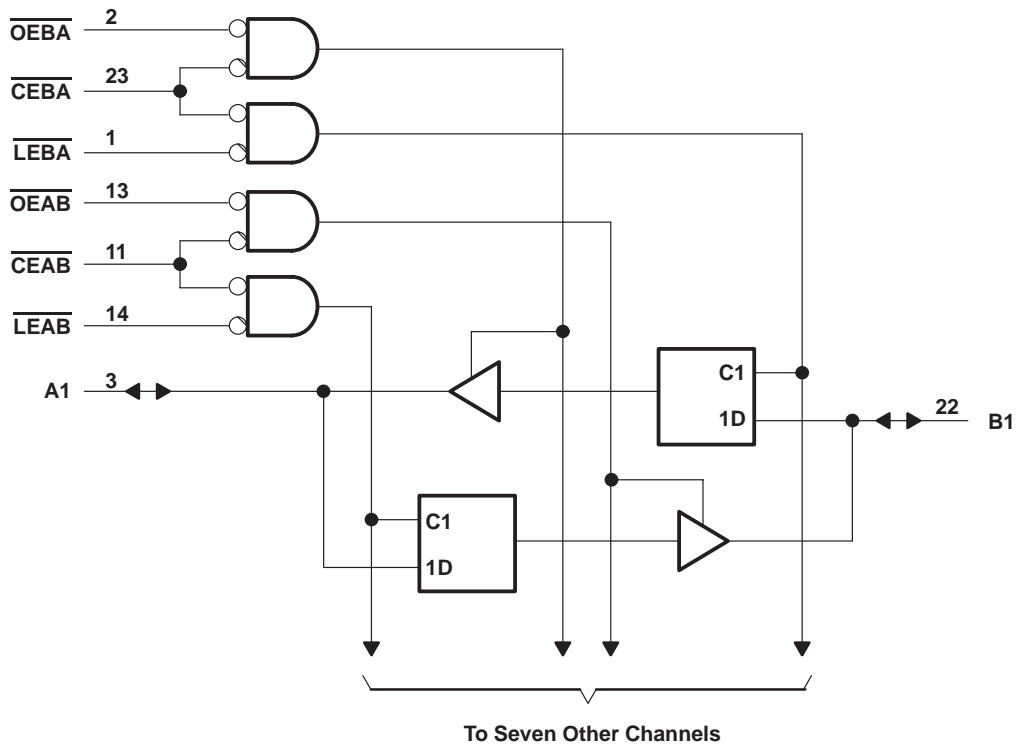
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## logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## logic diagram (positive logic)



**SN74F543**  
**OCTAL REGISTERED TRANSCEIVER**  
**WITH 3-STATE OUTPUTS**

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**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

Supply voltage range, $V_{CC}$ .....	–0.5 V to 7 V
Input voltage range, $V_I$ (excluding I/O ports) (see Note 1) .....	–1.2 V to 7 V
Input current range, $I_{IK}$ .....	–30 mA to 5 mA
Voltage range applied to any output in the disabled or power-off state .....	–0.5 V to 5.5 V
Voltage range applied to any output in the high state .....	–0.5 V to $V_{CC}$
Current into any output in the low state: A1–A8 .....	48 mA
B1–B8 .....	128 mA
Operating free-air temperature range .....	0°C to 70°C
Storage temperature range .....	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input-voltage ratings may be exceeded provided the input-current ratings are observed.

**recommended operating conditions**

		MIN	NOM	MAX	UNIT
$V_{CC}$	Supply voltage	4.5	5	5.5	V
$V_{IH}$	High-level input voltage	2			V
$V_{IL}$	Low-level input voltage			0.8	V
$I_{IK}$	Input clamp current			–18	mA
$I_{OH}$	High-level output current	A1–A8		–3	mA
		B1–B8		–15	
$I_{OL}$	Low-level output current	A1–A8		24	mA
		B1–B8		64	
$T_A$	Operating free-air temperature	0		70	°C



# SN74F543

## OCTAL REGISTERED TRANSCEIVER WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT
$V_{IK}$		$V_{CC} = 4.5\text{ V}$ ,	$I_I = -18\text{ mA}$			-1.2	V
$V_{OH}$	A1–A8	$V_{CC} = 4.5\text{ V}$	$I_{OH} = -1\text{ mA}$	2.5	3.4		V
			$I_{OH} = -3\text{ mA}$	2.4	3.3		
	B1–B8		$I_{OH} = -3\text{ mA}$	2.4	3.3		
			$I_{OH} = -15\text{ mA}$	2	3.1		
Any output		$V_{CC} = 4.75\text{ V}$ ,	$I_{OH} = -1\text{ mA to } -3\text{ mA}$	2.7			
$V_{OL}$	A1–A8	$V_{CC} = 4.5\text{ V}$	$I_{OL} = 24\text{ mA}$		0.3	0.5	V
	B1–B8		$I_{OL} = 64\text{ mA}$		0.42	0.55	
$I_I$	$\overline{OE}$ , $\overline{LE}$ , and $\overline{CE}$	$V_{CC} = 5.5\text{ V}$	$V_I = 7\text{ V}$			0.1	mA
	A and B ports		$V_I = 5.5\text{ V}$			1	
$I_{IH}‡$	$\overline{OE}$ , $\overline{LE}$ , and $\overline{CE}$	$V_{CC} = 5.5\text{ V}$ ,	$V_I = 2.7\text{ V}$			20	$\mu\text{A}$
	A and B ports					70	
$I_{IL}‡$	$\overline{OE}$ , $\overline{LE}$ , and $\overline{CE}$	$V_{CC} = 5.5\text{ V}$ ,	$V_I = 0.5\text{ V}$			-1.2	mA
	A and B ports					-0.65	
$I_{OS}§$	A1–A8	$V_{CC} = 5.5\text{ V}$ ,	$V_O = 0$			-60	mA
	B1–B8					-100	
$I_{CCH}$		$V_{CC} = 5.5\text{ V}$			67	100	mA
$I_{CCL}$		$V_{CC} = 5.5\text{ V}$			83	125	mA
$I_{CCZ}$		$V_{CC} = 5.5\text{ V}$			83	125	mA

† All typical values are at  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ For I/O ports, the parameters  $I_{IH}$  and  $I_{IL}$  include the off-state output current.

§ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

### timing requirements

		$V_{CC} = 5\text{ V}$ , $T_A = 25^\circ\text{C}$		$V_{CC} = 4.5\text{ V to } 5.5\text{ V}$ , $T_A = \text{MIN to MAX}¶$		UNIT
		MIN	MAX	MIN	MAX	
$t_w$	Pulse duration	5		5		ns
$t_{su}$	Setup time, data before latch enable		High or low	3	3.5	ns
$t_h$	Hold time, data after latch enable		High or low	3	3.5	ns

¶ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

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**switching characteristics (see Note 2)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 5 V, C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500 Ω, T <sub>A</sub> = 25°C			V <sub>CC</sub> = 4.5 V to 5.5 V, C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500 Ω, T <sub>A</sub> = MIN to MAX†		UNIT
			MIN	TYP	MAX	MIN	MAX	
t <sub>PLH</sub>	A or B	B or A	2.2	5.1	7.5	2.2	8.5	ns
t <sub>PHL</sub>			2.2	4.6	6.5	2.2	7.5	
t <sub>PLH</sub>	$\overline{LEBA}$	A	3.7	8.1	11	4.1	12.5	ns
t <sub>PHL</sub>			3.7	8.1	11	4.1	12.5	
t <sub>PLH</sub>	$\overline{LEAB}$	B	3.7	8.1	11	4.1	12.5	ns
t <sub>PHL</sub>			3.7	8.1	11	4.1	12.5	
t <sub>PZH</sub>	$\overline{OE}$ or $\overline{CE}$	A or B	2.2	6.6	9	2.2	10	ns
t <sub>PZL</sub>			3.2	7.1	10.5	3.2	12	
t <sub>PHZ</sub>	$\overline{OE}$ or $\overline{CE}$	A or B	1.7	5.6	8	1.7	9	ns
t <sub>PLZ</sub>			1.7	5.1	7.5	1.7	8.5	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 2: Load circuits and waveforms are shown in Section 1.



**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74F543DBLE	OBSOLETE	SSOP	DB	24		TBD	Call TI	Call TI
SN74F543DBR	ACTIVE	SSOP	DB	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74F543DBRE4	ACTIVE	SSOP	DB	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74F543DBRG4	ACTIVE	SSOP	DB	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74F543DW	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74F543DWE4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74F543DWG4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74F543DWR	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74F543DWRE4	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74F543DWRG4	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74F543NSRE4	ACTIVE	SO	NS	24		TBD	Call TI	Call TI
SN74F543NSRG4	ACTIVE	SO	NS	24		TBD	Call TI	Call TI
SN74F543NT	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74F543NTE4	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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## TAPE AND REEL INFORMATION



### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74F543DBR	SSOP	DB	24	2000	330.0	16.4	8.2	8.8	2.5	12.0	16.0	Q1
SN74F543DWR	SOIC	DW	24	2000	330.0	24.4	10.75	15.7	2.7	12.0	24.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74F543DBR	SSOP	DB	24	2000	346.0	346.0	33.0
SN74F543DWR	SOIC	DW	24	2000	346.0	346.0	41.0

DB (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

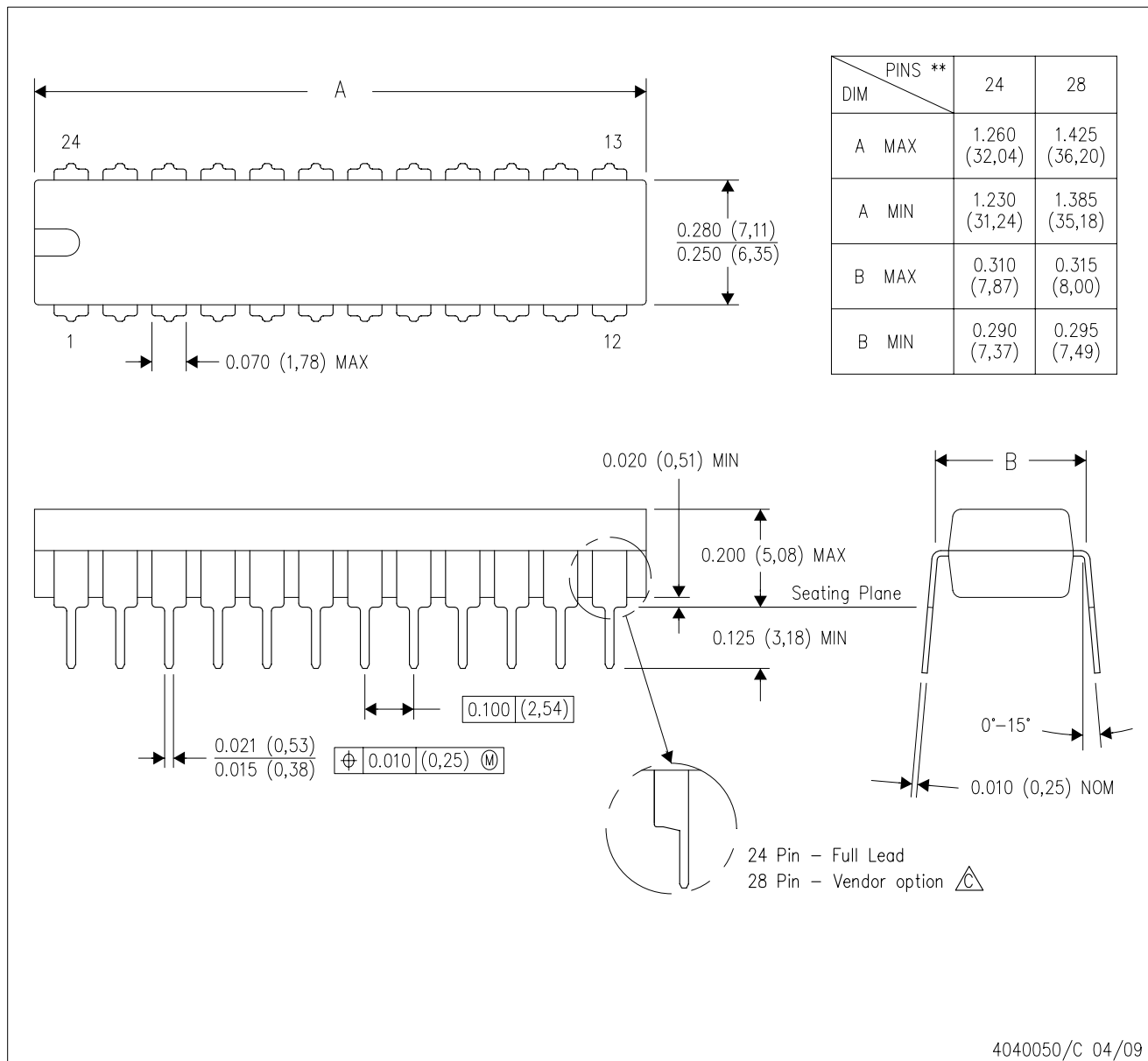



# MECHANICAL DATA

NT (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

24 PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  -  The 28 pin end lead shoulder width is a vendor option, either half or full width.



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